

Built-in PMW 16-channel constant current LED driver

Overview

CFD435AQP9 is a high-end driver specially designed for LED display ,which is driven by 16-channel constant-current sink current.

CFD435AQP9 has built-in 16K SRAM to store display data, which effectively solves the problem of transmission bandwidth limitation. At the same time, the driver adopts PWM gray scattering scan mode, which greatly improves the gray level of the display and shooting refresh rate.

CFD435AQP9 has built-in dynamic low-power technology to eliminate useless power consumption, which can effectively reduce the overall display temperature.

CFD435AQP9 has a variety of gray compensation mechanisms and high-precision linear current gain to make the color restoration of the display more accurate.

CFD435AQP9 has current gray compensation technology, which can effectively improve the low gray refresh rate.

CFD435AQP9 has the function of opencircuit detection and protection, which can detect and eliminate the cross caused by open -circuit point in real time.

CFD435AQP9 is packaged in QSOP24 and the normal operating temperature range is -40°C to 85°C.

Characteristic parameter

- Operating voltage: 3v~5.5v
- Built-in PWM gray control, easy to achieve built-in high gray and high refresh rate
- 16K SRAM, up to 32 scan
- PWM refresh multiplier technology and GCLK multiplier technologe
- Current gray technologe
- Built-in dynamic energy saving technology, reducing useless power consumption
- Built-in column blanking function
- A variety of gray compensation methods to eliminate low gray and cross-board color deviation
- 64-level global current gain
- Four-level programmable constant-current knee point (0.2V/0.3V/0.4V/0.5V)
 - Current output range: 0.3~25mA @VDD=5V

0.3~12mA @VDD=3.3V

- Current accuracy
- Between channels:
 - $\pm 1.2\%$ (Typical) $\pm 1.5\%$ (Max)

Between ICs:

- $\pm 1.2\%$ (Typical) $\pm 1.5\%$ (Max)
- SPI-like interface , up to 30Mhz
- Built-in ghosting elimination function
- Effectively preventing caterpillars through port voltage clamp technology
- Built-in open-circuit detection function to silently eliminate open -circuit cross in real time

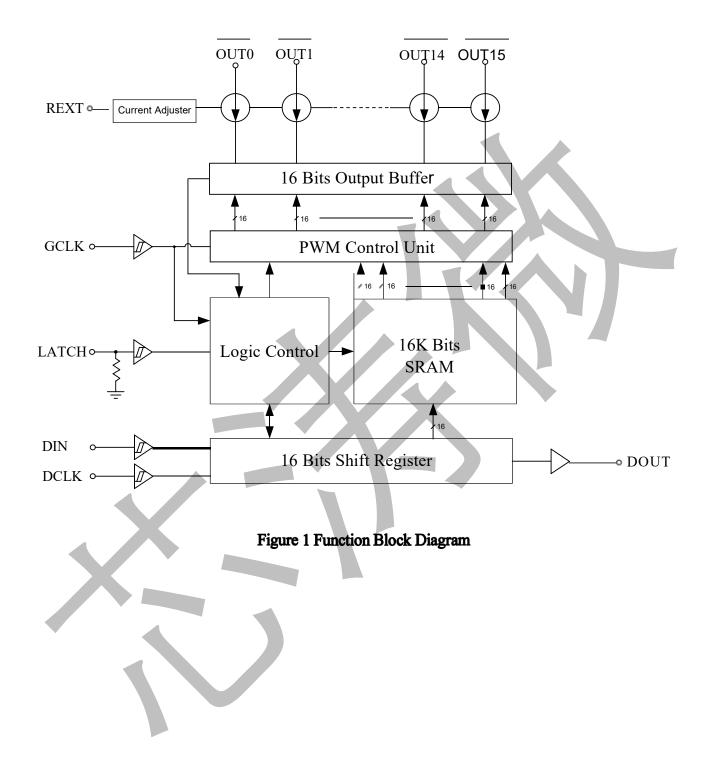
Typical applications

- Outdoor or indoor LED display
- LED display on mobile phones or other handheld devices
- Keyboard or mouse backlight
- White goods
- Smart speaker

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Function Block Diagram





Pin Diagram

Package	Pin Diagram (Top view)		
Package QSOP24	Pin Diagram (Top view) GND D IN DCLK LATCH OUT0 OUT1 OUT2 OUT2 OUT3 OUT4 OUT5 OUT6 OUT7	2 23 3 22 4 21 5 20 6 19 7 18 8 17 9 16 10 15 11 14	<u>GCLK</u> <u>OUT15</u> <u>OUT14</u> <u>OUT13</u> <u>OUT12</u> <u>OUT1</u> 1 <u>OUT1</u> 1

Pin Description

Sympol	Pin Number	Description		
GND	1	Ground		
DIN	2	Serial data input		
DCLK	3	Clock signal,, positive edge sampling		
LATCH	4	Internal data latch signal, different commands can be distinguished by identifying the length of LATCH		
OUTO ~OUT15	5~20	Constant current output driving channel		
GCLK	21	PWM gray clock		
DOUT	12	Serial data output, the next IC can be cascaded		
REXT	23	The external reference resistance is connected to the pin, and the constant current of the channel can be adjusted by changing the resistance		
VDD	24	Power		



Order Information

Storage temperature: $-65^{\circ}C \sim +150^{\circ}C$

Part Number	Package	Packaging form	Quantity/Reel	Reel /Box	
CFD435AQP9	QSOP24	Vacuum Tape	2500	8	

I/O Equivalent Circuit

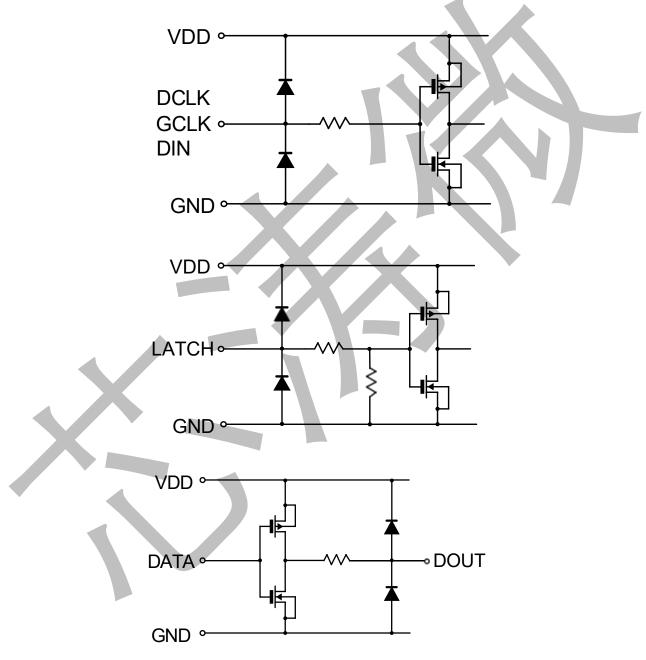


Figure 2 I/O Equivalent Circuit



Limit Parameter

VDD	-0.3v ~ +0.6v		
Input voltage	-0.4v ~ VCC+0.4v		
T _{JMAX}	+125°C		
T _{STG}	-65°C~150°C		
T _A	-40°C ~+85°C		
I _{OUT}	20mA		
I _{GND}	360mA		
F _{DCLK} / F _{GCLK}	30MHz		
Rth	75°C/W		
Pp	1600mw (T _A =25°C)		
	750mw (T _A =80°C)		
ESD (HBM)	±6KV		

Electrical Parameter (VDD=5V, TA=25°C, current gain GCC is set to "111111", PWM date=0xFFFF)

Sympol	Parameter	Condition	MIN	ТҮР	MAX	Unite
V _{DD}	Operating Voltage		3		5.5	V
Ісс	Static Operating Current	ALL INPUT=0 All output off REXT=2K		5	7	mA
	Output Constant Current	V _{OUT} =0.55V		8.6		mA
Isg	&Error	REXT=2K			±1.5	%
Vout	Constant Current Output Voltage	I _{OUT} =15mA	550			mV
%/Vdd	Constant Current Output Change (VS VDD)	Iout=10mA		±1.5		%/V
%/Vout	Constant Current Output Change (VS VOUT)	IOUT=10mA		±0.1		%/V
Logic Elect	trical Parameter (DIN 、DCLK	GCLK, LAT	CH&DOUT)			
VIH	High-Level Input Voltage	VCC=5V	3.5	•		V
VIL	Low-Level Input Voltage	VCC=5V			1.5	V
IIL	Low-Level Input Current	V _{INPUT} =0V (DCLK,				nA
		GCLK, DIN,			10	
		LATCH)				



Іш	High-Level Input Current	V _{INPUT} =5V (DCLK, GCLK, DIN)			10	nA
		V _{INPUT} =5V (LATCH)		100		uA
Vol	Low-Level Output Voltage	I _{OL} =1mA (DOUT)			0.4	N.
V _{он}	High-Level Output Voltage	I _{OH} =-1mA (DOUT)	4.6			V

AC Parameter (VDD=5V, TA=25°C, current gain GCC is set to "111111", PWM date=0xFFFF)

Sympol	Parameter	Condition	MIN	ТҮР	MAX	Unite
T _{pLH1}	Low to high transmission delay DCLK->DOUT			10	20	ns
T _{pLH2}	Low to high transmission delay GCLK->OUTn			20	40	ns
T _{pHL1}	High to low transmission delay DCLK->DOUT			10	20	ns
T _{pHL2}	High to low transmission delay GCLK->OUTn	VIH=VDD		20	40	ns
T _{SETUP1}	LATCH setup time	VIL=GND	10			ns
Thlod1	LATCH hold time	REXT=750 Ω	10			ns
T SETUP2	DIN setup time	VL=4.5V	3			ns
Thlod2	DIN hold time	RL=150Ω	5			ns
Twdclk	DCLK pulse width	CL=10Pf		15		ns
TWLATCH	LATCH pulse width			15		ns
Twgclk	GCLK pulse width		30			ns
Tor	Output channel rise time		30			ns
T ₀ f	Output channel fall time		15			ns

AC Sequence Diagram



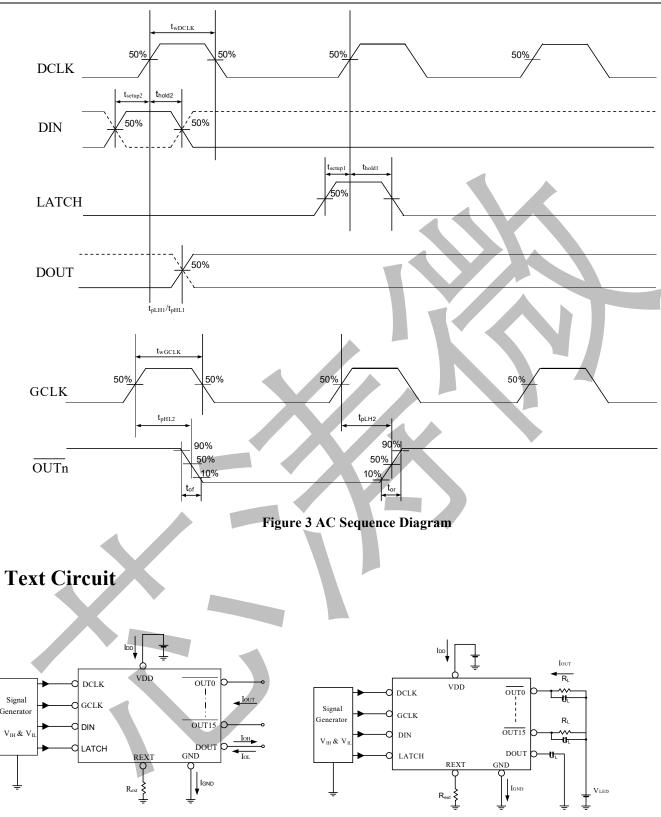


Figure 4-1 DC Characteristics Test





Constant Current Characteristics

CFD435AQP9 adopts constant current driving mode. When the VDS voltage is greater than the output minimum breakover voltage, the channel driver enters the constant current state, and the channel current is no longer affected by the change of VDS. The current precision control technology is adopted inside the IC, which can maintain high consistency between channels and between ICs.

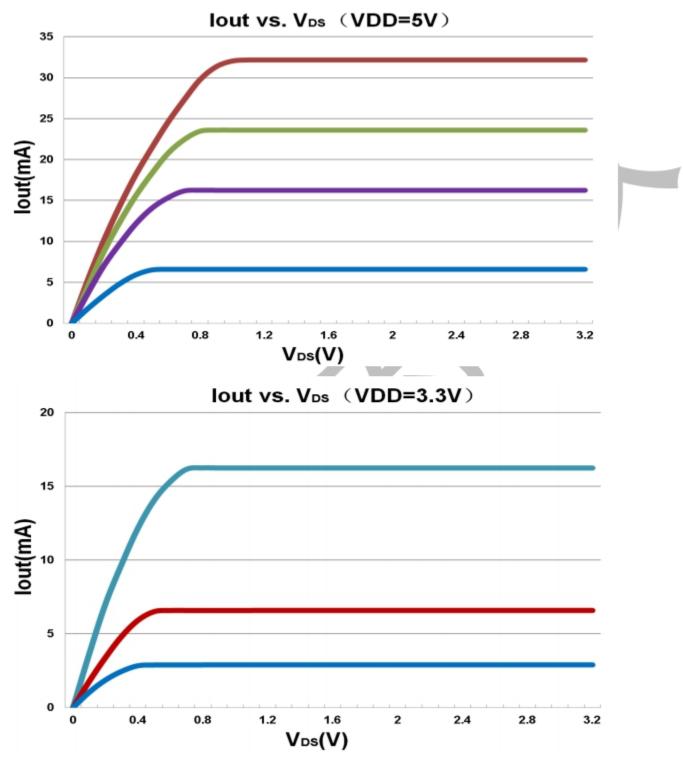


Figure 5 Constant Current Characteristic Curve



Constant current output calculation

GCC 6BIT global current gain value control the Iour of OUT0~OUT15

$$I_{OUT} = \frac{218}{Rext} \times (17 + GCC)$$
$$GCC = \sum_{n=0}^{5} B[n] \times 2^{n}$$

"n" corresponds to the position of GCC bit, B [n] represents the binary value (0 or 1)of the corresponding position of GCC.

Rext is the resistance for the external current, assuming Rext = 2000 ohms After power on by default, B5:B0=000000,GCC=0,

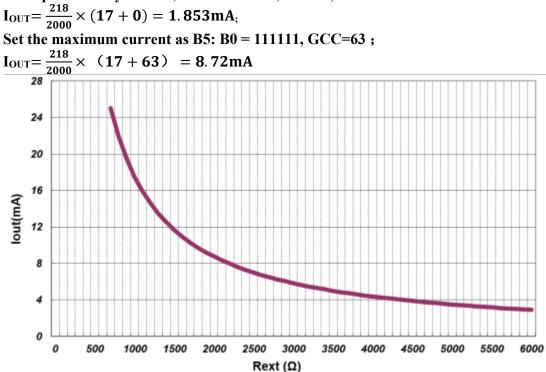


Figure 6 Corresponding relationship between output current and rext resistance (GCC = 11111)

This current I_{OUT} is the peak current and the actual output average current needs to be combined with PWM data and scan number.



Low-power application

The IC register provides two-level programmable constant current knee point. In practical applications, users can slect the suitable one according to the forward voltage(Vf) which the LED used. Then a lower voltage can be used to achieve the low-power application. Since the forward voltage of the red lights and green lights and blue lights are quite different, the application can be independently selected and set according to the actual situation.

Package heat dissipation power PD

Each type of IC package form has a maximum limit power. IC products must run within the limit power to ensure product reliability. The maximum limit power PD(max) = (Tj,max-Tamb)/Rth(j-a). Among them, Tj,max is the maximum junction temperature of the IC and usually selects 150°C;Tamb is the ambience temperature, and Rth(j-a) is the thermal resistance of the package.

Welding instructions

The pin plating of this product complies with the RoHS standard and supports the usual tin-lead process and lead-free process. When the user uses the tin-lead process, the welding temperature range is 215° C to 245° C; when using the lead-free process, the temperature needs to comply with the J-STD-020 standard of 245° C to 260° C.



QSOP24 Package Information

